EMBEDDED COM EXPRESS® TYPE 6





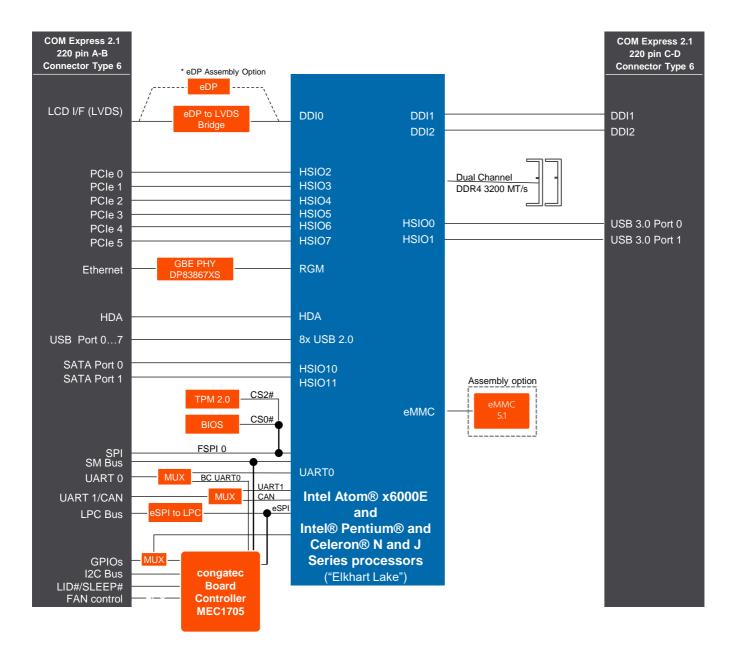
- COM Express Type 6 Compact based on Intel® Atom® x6000E Series and Intel® Pentium® and Celeron® J and N Series processors
- High performance Intel® UHD Graphics (Gen11)
- Options for Industrial Temperature Range -40°C to 85°C
- Options for Time Sensitive Networking and Time Coordinated Computing for improved Realtime Capability
- 3.200 MT/s DDR4 SODIMM Memory Support

Form Factor	COM Express® Compact Type 6 (95 x 95 mm)						
CPU	Processor	TDP	Cores/Threads	Base Frequ./Turbo	Gen 11 Gfx	Intel Use Condition	
	J6413	10W	4/4	1.8 GHz / 3.0 GHz	16 EU	PC Client	
	J6426	10W	4/4	2.0 GHz / 3.0 GHz	32 EU	PC Client	
	x6211E	6W	2/2	1.3 GHz / 3.0 GHz	16 EU	Embedded	
	x6413E	9W	4/4	1.5 GHz / 3.0 GHz	16 EU	Embedded	
	x6425E	12W	4/4	2.0 GHz / 3.0 GHz	32 EU	Embedded	
	x6212RE	6W	2/2	1.2 GHz /	16 EU	Industrial	
	x6414RE	9W	4/4	1.5 GHz /	16 EU	Industrial	
	x6425RE	12W	4/4	1.9 GHz /	32 EU	Industrial	
DRAM	Support for 2x SO DIMM on socket (dual channel DDR4 3.200 MT/s) max. 32 GB system capacity						
Ethernet	Intel® GbE with TSN support and Out-Of-Band Management real-time trigger						
I/O Interfaces	Up to 6x PCle Gen3 2x USB 3.1 Gen2 up to 8x USB 2.0 2x SATA III 2x UART (UART1 muxed with CAN) GPIO I ² C Bus SMBus SPI LPC						
Mass Storage	Option for onboard eMMC 5.1 flash up to 128 Gbyte						
Audio	Intel® HD Audio						
Graphics	Intel® UHD Graphics (Gen11)						
LVDS	Dual channel 18/24-bit LVDS interface up to 1920x1200@60Hz shared with eDP up to 3840x2160@60Hz (option)						
Digital Display Interface	2x DisplayPort 1.4 4096x2160@60Hz						
congatec Board controller	Multistage watchdog non-volatile user data storage manufacturing and board Information board statistics fast mode and multi-master I ² C bus power loss control						
Embedded BIOS Feature	AMI Aptio® UEFI firmware 32 MByte serial SPI with congatec Embedded BIOS features OEM Logo OEM CMOS Defaults LCD Control Display Auto Detection Backlight Control Flash Update						
Power Management	ACPI 5 .0 compliant Smart Battery Management						
Operating Systems	Microsoft® Windows 10 Microsoft® Windows 10 IoT Enterprise Linux (Yocto Project) Android RTS Hypervisor						
Power Consumption	Typ. Applicat	Typ. Application: see manual for full details					
Temperature Range	Commercial: Industrial:		g Temperature: 0 t g Temperature: -40			re: -20 to +80°C re: -40 to +85°C	
Humidity	Operating Hu Storage Hum	-	0 to 90% r. H. non c 5 to 95% r. H. non c				
Size	95 x 95 mm (approx. 3.7	'4" x 3.74")				





conga-TCA7 | Block Diagram



Note: Assembly options on request only



conga-TCA7 | Order Information

Article	PN	Description		
conga-TCA7/x6425E	049300	COM Express Compact module with Intel Atom® x6425E quad core processor with 2.0GHz core frequency up to 3.0GHz, 1.5MB cache and up to 32GB 3200MT/s DDR4 SODIMM memory support		
conga-TCA7/x6413E	049301	COM Express Compact module with Intel Atom® x6413E quad core processor with 1.5GHz core frequency up to 3.0GHz, 1.5MB cache and up to 32GB 3200MT/s DDR4 SODIMM memory support		
conga-TCA7/x6211E	049302	COM Express Compact module with Intel Atom® x6211E dual core processor with 1.3GHz core frequency up to 3.0GHz, 1.5MB cache and up to 32GB 3200MT/s DDR4 SODIMM memory support		
conga-TCA7/i-x6425RE	049310	COM Express Compact module with Intel Atom® x6425RE quad core processor with 1.9GHz core frequency, 1.5MB cache and up to 32GB 3200MT/s DDR4 SODIMM memory support. Industrial grade temperature range from -40°C to 85°C.		
conga-TCA7/i-x6414RE	049311	COM Express Compact module with Intel Atom® x6414RE quad core processor with 1.5GHz core frequency, 1.5MB cache and up to 32GB 3200MT/s DDR4 SODIMM memory support. Industrial grade temperature range from -40°C to 85°C.		
conga-TCA7/i-x6212RE	049312	COM Express Compact module with Intel Atom® x6212RE dual core processor with 1.2GHz core frequency, 1.5MB cache and up to 32GB 3200MT/s DDR4 SODIMM memory support. Industrial grade temperature range from -40°C to 85°C.		
conga-TCA7/J6426	049320	COM Express Compact module with Intel® Pentium® J6426 quad core processor with 2.0GHz core frequency up to 3.0GHz, 1.5MB cache and up to 32GB 3200MT/s DDR4 SODIMM memory support.		
conga-TCA7/J6413	049321	COM Express Compact module with Intel® Celeron® J6413 quad core processor with 1.8GHz core frequency up to 3.0GHz, 1.5MB cache and up to 32GB 3200MT/s DDR4 SODIMM memory support		
conga-TCA7/i-HSP-B	049350	Standard heatspreader for COM Express Compact module conga-TCA7 with lidded Intel Atom x6000E processors. All standoffs are with 2.7mm bore hole.		
conga-TCA7/i-HSP-T	049351	Standard heatspreader for COM Express Compact module conga-TCA7 with lidded Intel Atom x6000E processors. All standoffs are M2.5mm thread.		
conga-TCA7/i-CSP-B	049352	Passive cooling solution for COM Express Compact module conga-TCA7 with lidded Intel Atom x6000E processors. All standoffs are with 2.7mm bore hole.		
conga-TCA7/i-CSP-T	049353	Passive cooling solution for COM Express Compact module conga-TCA7 with lidded Intel Atom x6000E processors. All standoffs are M2.5mm thread.		
conga-TCA7/HSP-B	049354	Standard heatspreader for COM Express Compact module conga-TCA7 with open silicon Intel Pentium/Celeron J and N processors. All standoffs are with 2.7mm bore hole.		
conga-TCA7/HSP-T	049355	Standard heatspreader for COM Express Compact module conga-TCA7 with open silicon Intel Pentium/Celeron J and N processors. All standoffs are M2.5mm thread.		
conga-TCA7/CSP-B	049356	Passive cooling solution for COM Express Compact module conga-TCA7 with open silicon Intel Pentium/Celeron J and N processors. All standoffs are with 2.7mm bore hole.		
conga-TCA7/CSP-T	049357	Passive cooling solution for COM Express Compact module conga-TCA7 with open silicon Intel Pentium/Celeron J and N processors. All standoffs are M2.5mm thread.		

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